# 2SB0936, 2SB0936A (2SB936, 2SB936A)

### Silicon PNP epitaxial planar type

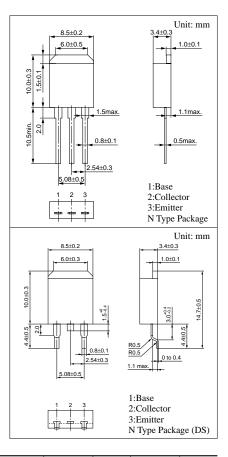
For low-voltage switching

#### Features

- Low collector to emitter saturation voltage V<sub>CE(sat)</sub>
- High-speed switching
- N type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment.

#### Absolute Maximum Ratings (T<sub>C</sub>=25°C)

Parameter		Symbol	Ratings	Unit	
Collector to	2SB0936	37	-40	V	
base voltage	2SB0936A	$V_{CBO}$	-50		
Collector to	2SB0936	37	-20	V	
emitter voltage	2SB0936A	$V_{CEO}$	-40		
Emitter to base voltage		$V_{\mathrm{EBO}}$	-5	V	
Peak collector current		$I_{CP}$	-20	A	
Collector current		$I_C$	-10	A	
Collector power	T <sub>C</sub> =25°C	D	40	W	
dissipation	Ta=25°C	$P_{C}$	1.3		
Junction temperature		T <sub>j</sub>	150	°C	
Storage temperature		$T_{stg}$	-55 to +150	°C	



#### Electrical Characteristics (T<sub>C</sub>=25°C)

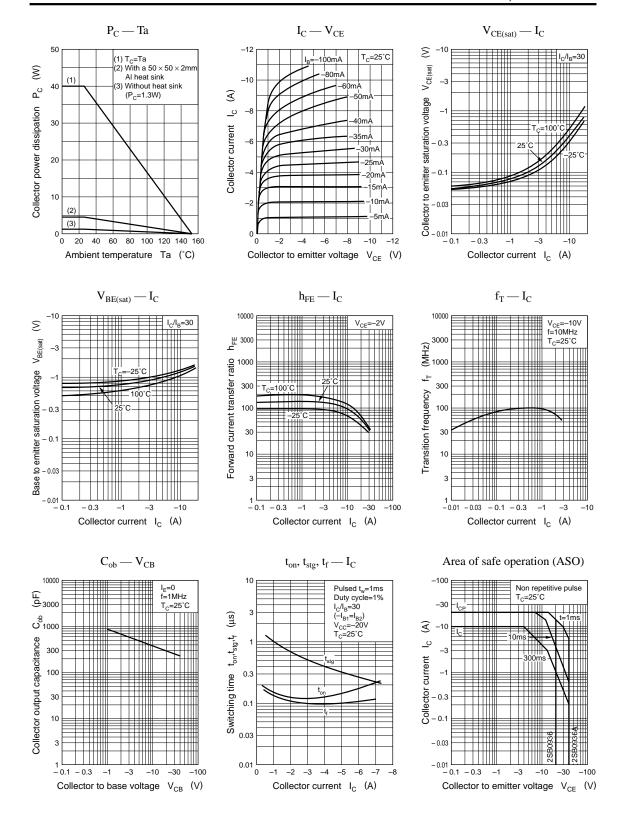
Parameter		Symbol	Conditions	min	typ	max	Unit	
Collector cutoff	2SB0936	_	$V_{CB} = -40V, I_{E} = 0$			-50		
current	2SB0936A	I <sub>CBO</sub>	$V_{CB} = -50V, I_{E} = 0$			-50	μΑ	
Emitter cutoff current		I <sub>EBO</sub>	$V_{EB} = -5V, I_C = 0$			-50	μА	
Collector to emitter	2SB0936	$V_{CEO}$ $I_C = -10$ mA, $I_B = 0$	-20					
voltage	2SB0936A		$I_C = -10$ mA, $I_B = 0$	-40			V	
Forward current transfer ratio		h <sub>FE1</sub>	$V_{CE} = -2V, I_C = -0.1A$	45				
		h <sub>FE2</sub> *	$V_{CE} = -2V, I_{C} = -3A$	90		260		
Collector to emitter saturation voltage		V <sub>CE(sat)</sub>	$I_C = -10A, I_B = -0.33A$			- 0.6	V	
Base to emitter saturation voltage		V <sub>BE(sat)</sub>	$I_C = -10A, I_B = -0.33A$			-1.5	V	
Transition frequency		$f_T$	$V_{CE} = -10V, I_{C} = -0.5A, f = 10MHz$		100		MHz	
Collector output capacitance		C <sub>ob</sub>	$V_{CB} = -10V, I_E = 0, f = 1MHz$		400		pF	
Turn-on time		t <sub>on</sub>	$I_C = -3A$ , $I_{B1} = -0.1A$ , $I_{B2} = 0.1A$		0.1		μs	
Storage time		t <sub>stg</sub>			0.5		μs	
Fall time		t <sub>f</sub>			0.1		μs	

#### \*h<sub>FE2</sub> Rank classification

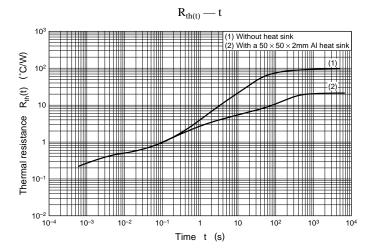
Rank	Q	P
h <sub>FE2</sub>	90 to 180	130 to 260

Note) The part numbers in the parenthesis show conventional part number.

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